





PFMC for CFETR

G. -N. Luo

Institute of Plasma Physics, CAS, Hefei, Anhui, China

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- Strategy of PFMC for EAST
- > Status of R & D for W/Cu-PFMC
- **D PFMC for CFETR and technology readiness**
 - > Three phases of CFETR
 - > Plasma-facing, heat sink and structural materials
 - > Water-cooling vs He-cooling
 - **>** Rough schedule for PFMC in China

Summary







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Summary



PFMC corresponding to different phases

- Initial phase (2006-2007), PFM was SS plate bolted to the support w/o active cooling
- First phase (2008-2010) with limited heating (max. heat flux onto divertor ~ 2MW/m²), PFM is mainly SiC-coated doped graphite tiles bolted to Cu heat sink
- **Transition phase (2011-2013) TZM on FW, still C on Div**
- Second phase (2014-) with more heating (>10MW), PFCs will be changed into actively-cooled W/Cu-PFC gradually (max. heat removal from divertor ~10MW/m²) \$\Rightarrow ITER-like PFMC
- **Future phases** He-cooled PFMC (500^oC); flowing Li wall

Status of R & D for W/Cu-PFMC HT-7/ EAST

EAST W/Cu Project

• <u>Divertor</u>:

ITER-like configuration and structure, i.e., Monoblock targets and W Flat type or CVD-W dome

Max. heat flux capability of divertor targets ~10MW/m²

• <u>First wall</u>:

CVD-W or W flat type

Max. heat flux capability 3~5MW/m²





- **ITER grade W** has been manufactured in batch scale
- W/Cu monoblocks prepared by means of HIP technology
- **ITER-like W/Cu mockups in collaboration with domestic and foreign institutions**



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ASIPP

• W/Cu mockup with five W tiles was manufactured successfully by Hot Radial Pressing (HRP), showing good bonding between monoblocks and CuCrZr tube.



 The first test W/Cu mockup with four W monoblock tiles was manufactured by Hot Isostatic Pressing (HIP). And the technology will be kept improving.



Innovative technology combinations

- \succ HIP + HIP
- \succ HIP + HRP

HT_7/

EAS₇



Flat-type W/Cu PFMC

Flat-type W/Cu mockups have been being manufactured by means of various technologies

- Two-step HIP or VHP: The interface of W/Cu were joined by HIP or vacuum hot pressing (VHP) at higher temperature of ~900℃, and then the interface of Cu/CuCrZr was bonded by VHP or HIP at lower temperature of 500~600℃.
- VPS & CVD coatings: Cu/CuCrZr by VHP / HIP, then coating.





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EAST

Ultrasonic NDT for monoblock-PFCs HT-7/ ASIPP

Single reflector sensor, spiral scanning ultrasonic inspection of W/Cu interface





Ultrasonic NDT by single probe proves feasibility to the issue, however showing poor measurement efficiency and difficulty in curved tubes. We are developing a phased array ultrasonic method.



2012-5-31

Z Eddy current NDT for monoblock-PFCs HT-7/ EAST

ASIPP

> We are also developing an innovative eddy current NDT method.



Advantage: (i) High-speed tube inspection; (ii) High sensitivity. To consider: (i)To reduce lift-off effect; (ii)To reduce edge effect among blocks; (iii)To reduce signal-noise ratio by develop multi-frequency technique.



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Three phases of CFETR



- **B**_{to} : 5.3 / 4.5 T
- I_p : 12 / 10/ 07 MA
- **R**_o : 5.5 m
- A : 1.6 m
- K : 1.8

Phase1: (incl. non- nuclear, 6-8 y) Ip = 6-7MA, B_T=4.5T, BetaN=1.5 H&CD: 50-60MW Q~1, t> 2 hour, SSO FTBM, mid-plane FFH BM (T>1.2) Pfusion ~ 50-100 MW SN, DN, ITER-W divertor, 3~5dpa

Phase 2: AT H-mode (DT-2, 6-8 y) Ip=10MA; B_T =5.3T, BetaN=2.5 H&CD: 80-100MW, Q~ 6-8 2-5 hours long pulse, SSO FTBM, mid-plane FFH BM(T>1.2) Pfus =300- 400MW, nw: 1MW/m² SN, DN, ITER-W divertor, ~ 20dpa **Phase 3: AT H-mode (DT-3, 6-8 y)** Ip=12MA; B_T =5.3T, BetaN=3.5-4 H&CD: 80-100MW, Q~10 Qeng>1, long pulse or SSO **FTBM (T>1.1) Pfus = 800MW, nw: 2MW/m² SN**, **DN**, **DEMO-divertor**, > 50dpa

PFMC technology readiness in China HT-7/ ASIPP

PFM for CFETR

- ITER-grade bulk W ⇒ Ready
- W coatings by VPS or CVD ⇒ R & D needed
- New grades of W (nano-structured, alloying or ODS-strengthened)
 ⇒ Initial R & D

Heat sink & structural materials

- CuCrZr & SS (Phase 1) ⇒ Ready, R & D of CuCrZr tube needed
- RAFM (Phases 2-3) ⇒ Ton level production, lack of n-effects
- ODS-RAFM or Vanadium alloy ⇒ Initial R & D

PFC structure

- Monoblock or flat-W/Cu/CuCrZr ⇒ R & D /1-2Y
- Monoblock or flat-W/RAFM ⇒ Not yet started
- He jet cooled design ⇒ Not yet started

Innovative concept

Flowing Li wall ⇒ Very initial, nothing considered for T plant !



Water cooling vs. He Cooling

HT-7/ EAST

	Water cooling	He cooling						
Chemical and neutronic activity	H_2O_2 formation due to neutron < 240°C corrosion to RAFM	Inertness						
Working temperature	> 300°C (n-defects annealing in RAFM) < material limit	> 500°C < material limit						
Pressure	15MPa @ 300°C (JP)	< 10MPa						
Heat conductivity	High	Low						
Cooling structure	Swirl tape, hypervaptron	Jet flow (higher heat removal efficiency)						
Foundation	PWR, ITER design	HTR, DEMO concept						
ITER design: water @ 4MPa/100 ⁰ C								



Choice of PFMC

Materials considered	Water cooling	He cooling
W, CuCrZr (heat sink), SS(support) - Phase 1	4MPa/<200 ^o C, 10-15MW/m ² CuCrZr (3-5dpa?)	<10MPa/<400°C 5-10MW/m ²
W, RAFM (heat sink + support) - Phase 1-2	15MPa/300 ^o C larger P @ higher T 10MW/m ²	<10MPa/<500°C 5-10MW/m ²
W & alloys, ODS-RAFM (heat sink + support) - Phase 3	15MPa/300 ^o C or larger P @ higher T 5-10MW/m ²	<10MPa/<600 ^o C 5-10MW/m ²
Flowing Li wall, Mo/RAFM (heat sink + support), - Phase 3+ ?	<400ºC (Li vaporize) Dangerous: Li + H ₂ O!	<400ºC (Li vaporize) Much safer: Li + He

Ø	Ro	ugh s	che	dule f	or P	FMC	in Ch	ina	HT-7/ EAST
	2012	2014	2016	2018	2020	2021	2026	2033	2040
EAST	C+Mo H2O	W/Cu+Mo H2O	W/Cu H2O	W/RAFM H2O/He?		W/RAFM He	W/ODS-RA He		
ITER						First Plas W/Cu/H2C W or Be/R	DT Oper)+Be/Cu/SS AFM/He (TE	/H2O 3M)	
CFETR				Star	t constru	ction	Phase 1 3-5dpa W/Cu H2O	Phase 2 20dpa W/RAFM H2O/He	Phase 3 50dpa W/ODS-FS He
R & D e ITER-like W/RAFM/ W/ODS-R Flowing I	efforts fo W/Cu/H20 /H2O or He AFM/He Li wall/He?	$\begin{array}{c} \text{or CFETR} \\ \text{o} \rightarrow 2014 \\ \text{o} \\ $			→ ~ 202	20 	Phase 1 > 2025-2030	Phase 2	Phase3







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□ Summary





Selection of PFMC is determined considering materials availability, PWI and radiation effects, cooling media and design, and technology readiness. Choices for CFETR are recommended below:

PHASE 1 – ITER design, i.e., water-cooled W/Cu/CuCrZr (4MPa/<200°C)

PHASE 2 – Water-cooled W/RAFM (15MPa/300°C) or Hecooled W/RAFM (10MPa/<500°C)

PHASE 3 – He-cooled W/ODS-RAFM (10MPa/>500°C)

PHASE 3+ - Flowing Li wall concept (200-400°C)

EAST will act as the best test device for ITER-like PFMC, for both ITER and CFETR (PHASE 1); and a test device for He-cooling PFMC







Thanks for your attention!